

# 40V, Low Quiescent Current, 150mA Linear Regulator

## ISL80138

The ISL80138 is a high voltage, adjustable  $V_{OUT}$  low quiescent current linear regulator ideally suited for "always-on" and "keep alive" applications. The ISL80138 operates from an input voltage of +6V to +40V under normal operating conditions and consumes only 18 $\mu$ A of quiescent current at no load.

The ISL80138 features an EN pin that can be used to put the device into a low-quiescent current shutdown mode where it draws only  $2\mu A$  of supply current. The device features over-temperature shutdown and current limit protection.

The ISL80138 is rated over the -40  $^{\circ}$ C to +125  $^{\circ}$ C temperature range and is available in a 14 lead HTSSOP with an exposed pad package.

**TABLE 1. KEY DIFFERENCES IN FAMILY OF 40V LDO PARTS** 

| PART NUMBER | MINIMUM I <sub>OUT</sub> | ADJ OR FIXED V <sub>OUT</sub> |
|-------------|--------------------------|-------------------------------|
| ISL80136    | 50mA                     | ADJ                           |
| ISL80138    | 150mA                    | ADJ                           |

# **Related Literature**

 See FN7970, "ISL80136 40V, Low Quiescent Current, 50mA Linear Regulator"

### **Features**

- Wide V<sub>IN</sub> Range of 6V to 40V
- Adjustable Output Voltage from 2.5V to 12V
- Guaranteed 150mA Output Current
- Ultra Low 18µA Typical Quiescent Current
- Low 2µA of Typical Shutdown Current
- ±1% Accurate Voltage Reference
- · Low Dropout Voltage of 295mV at 150mA
- 40V Tolerant Logic Level (TTL/CMOS) Enable Input
- Stable Operation with 10µF Output Capacitor
- 5kV ESD HBM Rated
- Thermal Shutdown and Current Limit Protection
- Thermally Enhanced 14 Ld Exposed Pad HTSSOP Package

# **Applications**

- Industrial
- Telecommunications

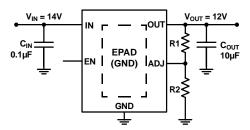


FIGURE 1. TYPICAL APPLICATION

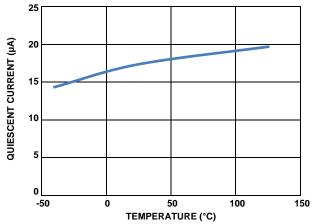
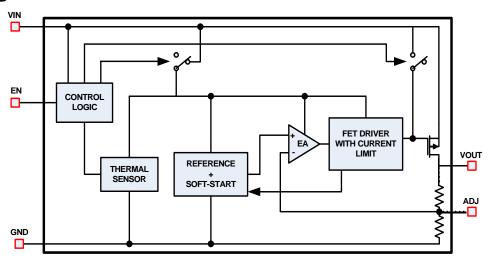
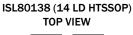


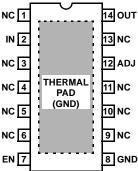
FIGURE 2. QUIESCENT CURRENT vs TEMPERATURE (AT UNITY GAIN).  $V_{\text{IN}} = 14V$ 

# **Block Diagram**



# **Pin Configuration**





# **Pin Descriptions**

| PIN NUMBER                      | PIN NAME | DESCRIPTION  |  |
|---------------------------------|----------|--|--|
| 1, 3, 4, 5, 6, 9,<br>10, 11, 13 | NC       | Pins have internal termination and can be left unconnected. Connection to ground is optional.                      |  |
| 2                               | IN       | Input voltage pin. A minimum 0.1µF ceramic capacitor is required for proper operation. Range 6V to 40V.            |  |
| 7                               | EN       | able pin. High on this pin enables the device. Range OV to V <sub>IN</sub> .                                       |  |
| 8                               | GND      | round pin.   |  |
| 12                              | ADJ      | This pin is connected to the external feedback resistor divider which sets the LDO output voltage. Range OV to 3V. |  |
| 14                              | OUT      | Regulated output voltage. A 10µF ceramic capacitor is required for stability. Range 0V to 12V.                     |  |
| -                               | EPAD     | It is recommended to solder the EPAD to the ground plane.  |  |

# **Ordering Information**

| PART NUMBER<br>(Notes 1, 2, 3) | PART<br>MARKING            | TEMP. RANGE<br>(°C) | ENABLE<br>PIN | OUTPUT VOLTAGE<br>(V) | PACKAGE<br>(Pb-Free) | PKG.<br>DWG. # |
|--------------------------------|----------------------------|---------------------|---------------|-----------------------|----------------------|----------------|
| ISL80138IVEAJZ                 | 80138 IAJZ                 | -40 to +125         | Yes           | ADJ                   | 14 Ld HTSSOP         | M14.173B       |
| ISL80138EVAL1Z                 | <b>Evaluation Platform</b> |                     |               | -                     |                      | ·              |

#### NOTES:

- 1. Add "-T\*" suffix for tape and reel. Please refer to TB347 for details on reel specifications.
- 2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 3. For Moisture Sensitivity Level (MSL), please see device information page for ISL80138. For more information on MSL please see techbrief TB363.

## **Absolute Maximum Ratings**

| IN Pin to GND Voltage                            | GND - 0.3V to +45V |
|--|--------------------|
| OUT Pin to GND Voltage                           | GND - 0.3V to 16V  |
| ADJ Pin to GND Voltage                           | GND - 0.3V to 3V   |
| EN Pin to GND Voltage                            | GND - 0.3V to VIN  |
| Output Short-circuit Duration                    | Indefinite         |
| ESD Rating                                       |                    |
| Human Body Model (Tested per JESD22-A114         | E) 5kV             |
| Machine Model (Tested per JESD-A115-A)           | 200V               |
| Charge Device Model (Tested per JESD22-C10       | 1C) 2.2kV          |
| Latch Up (Tested per JESD78B; Class II, Level A) | 100mA              |
|  |                    |

### **Thermal Information**

| Thermal Resistance (Typical)             | $\theta_{JA}$ (°C/W) | $\theta_{JC}$ (°C/W) |
|--|----------------------|----------------------|
| 14 Ld HTSSOP Package (Notes 4, 5)        | 37                   | 5                    |
| Maximum Junction Temperature             |                      | +150°C               |
| Maximum Storage Temperature Range        | 6                    | 5°C to +175°C        |
| Pb-Free Reflow Profile                   |                      | see link below       |
| http://www.intersil.com/pbfree/Pb-FreeRe | eflow.asp            |                      |

### **Recommended Operating Conditions**

| Ambient Temperature Range | 40°C to +125°C |
|---------------------------|----------------|
| IN pin to GND Voltage     | +6V to +40V    |
| OUT pin to GND Voltage    | +2.5V to +12V  |
| EN pin to GND Voltage     | 0V to +40V     |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

#### NOTES

- 4. θ<sub>JA</sub> is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief <u>TB379</u> for details.
- 5. For  $\theta_{JC}$ , the "case temp" location is the center of the exposed metal pad on the package underside.

**Electrical Specifications** Recommended Operating Conditions, unless otherwise noted.  $V_{IN} = 14V$ ,  $I_{OUT} = 1$ mA,  $C_{IN} = 0.1 \mu$ F,  $C_{OUT} = 10 \mu$ F,  $T_A = T_J = -40 \,^{\circ}$ C to +125  $^{\circ}$ C, unless otherwise noted. Typical specifications are at  $T_A = +25 \,^{\circ}$ C. **Boldface limits apply over the operating temperature range, -40 ^{\circ}C to +125 ^{\circ}C.** 

| PARAMETER                       | SYMBOL                          | TEST CONDITIONS   | MIN<br>(Note 8) | TYP   | MAX<br>(Note 8) | UNIT |
|---------------------------------|---------------------------------|---|-----------------|-------|-----------------|------|
| Input Voltage Range             | V <sub>IN</sub>                 |   | 6               |       | 40              | V    |
| Guaranteed Output<br>Current    | I <sub>OUT</sub>                | $V_{IN} = V_{OUT} + VDO$  | 150             |       |                 | mA   |
| ADJ Reference Voltage           | V <sub>OUT</sub>                | EN = High, V <sub>IN</sub> = 14V, I <sub>OUT</sub> = 0.1mA to 150mA                     | 1.211           | 1.223 | 1.235           | V    |
| Line Regulation                 | $\Delta V_{OUT}/\Delta V_{IN}$  | $3V \le V_{IN} \le 40V$ , $I_{OUT} = 1mA$   |                 | 0.04  | 0.15            | %    |
| Load Regulation                 | $\Delta V_{OUT}/\Delta I_{OUT}$ | V <sub>IN</sub> = V <sub>OUT</sub> +V <sub>DO</sub> , I <sub>OUT</sub> = 100μA to 150mA |                 | 0.3   | 0.6             | %    |
| Dropout Voltage                 | $\Delta V_{DO}$                 | I <sub>OUT</sub> = 1mA, V <sub>OUT</sub> = 3.3V   |                 | 7     | 33              | тV   |
| (Note 6)                        |                                 | I <sub>OUT</sub> = 150mA, V <sub>OUT</sub> = 3.3V                                       |                 | 380   | 525             | тV   |
|                                 |                                 | I <sub>OUT</sub> = 1mA, V <sub>OUT</sub> = 5V   |                 | 7     | 33              | m۷   |
|                                 |                                 | I <sub>OUT</sub> = 150mA, V <sub>OUT</sub> = 5V   |                 | 295   | 460             | m۷   |
| Shutdown Current                | I <sub>SHDN</sub>               | EN = LOW  |                 | 2     | 3.64            | -A   |
| Quiescent Current               | IQ                              | EN = HIGH, I <sub>OUT</sub> = 0mA   |                 | 18    | 24              | μΑ   |
|                                 |                                 | EN = HIGH, I <sub>OUT</sub> = 1mA   |                 | 22    | 42              | μΑ   |
|                                 |                                 | EN = HIGH, I <sub>OUT</sub> = 10mA  |                 | 34    | 60              | μΑ   |
|                                 |                                 | EN = HIGH, I <sub>OUT</sub> = 150mA   |                 | 90    | 125             | μΑ   |
| Power Supply<br>Rejection Ratio | PSRR                            | f = 100Hz; V <sub>IN_RIPPLE</sub> = 500mV <sub>P.P</sub> ; Load = 150mA                 |                 | 66    |                 | dB   |
| EN FUNCTION                     | 1                               |   | ,               |       |                 |      |
| EN Threshold Voltage            | V <sub>EN_H</sub>               | V <sub>OUT</sub> = Off to On  |                 |       | 1.485           | V    |
|                                 | V <sub>EN_L</sub>               | V <sub>OUT</sub> = On to Off  | 0.975           |       |                 | ٧    |
| EN Pin Current                  | I <sub>EN</sub>                 | V <sub>OUT</sub> = 0V   |                 | 0.026 |                 | μΑ   |
| EN to Regulation Time (Note 7)  | t <sub>EN</sub>                 |   |                 | 1.65  | 1.93            | ms   |

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| PARAMETER                      | SYMBOL             | TEST CONDITIONS             | MIN<br>(Note 8) | ТҮР  | MAX<br>(Note 8) | UNIT |
|--------------------------------|--------------------|-----------------------------|-----------------|------|-----------------|------|
| PROTECTION FEATURE             | S                  |                             |                 |      |                 |      |
| Output Current Limit           | I <sub>LIMIT</sub> | V <sub>OUT</sub> = OV       | 175             | 410  |                 | mA   |
| Thermal Shutdown               | T <sub>SHDN</sub>  | Junction Temperature Rising |                 | +165 |                 | °C   |
| Thermal Shutdown<br>Hysteresis | T <sub>HYST</sub>  |                             |                 | +20  |                 | °C   |

#### NOTES:

- 6. Dropout voltage is defined as ( $V_{IN}$   $V_{OUT}$ ) when  $V_{OUT}$  is 2% below the value of  $V_{OUT}$  when  $V_{IN}$  =  $V_{OUT}$  + 3V.
- 7. Enable to Regulation is the time the output takes to reach 95% of its final value with  $V_{IN} = 14V$  and EN is taken from  $V_{IL}$  to  $V_{IH}$  in 5ns. For the adjustable versions, the output voltage is set at 5V.
- 8. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

# $\textbf{Typical Performance Curves} \quad v_{\text{IN}} = \text{14V}, \ l_{\text{OUT}} = \text{1mA}, \ v_{\text{OUT}} = \text{5V}, \ T_{\text{J}} = \text{+25}\,^{\circ}\text{C}, \ \text{unless otherwise specified}.$

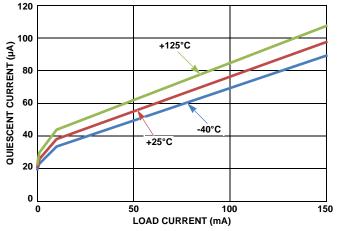


FIGURE 3. QUIESCENT CURRENT vs LOAD CURRENT

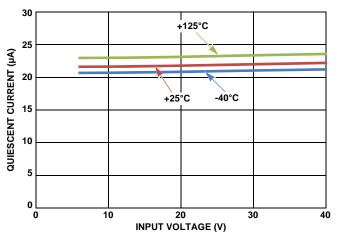


FIGURE 4. QUIESCENT CURRENT vs INPUT VOLTAGE (NO LOAD)

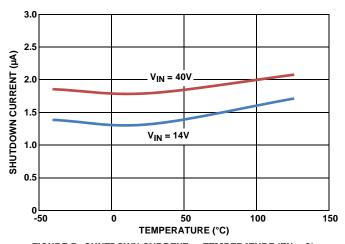


FIGURE 5. SHUTDOWN CURRENT vs TEMPERATURE (EN = 0)

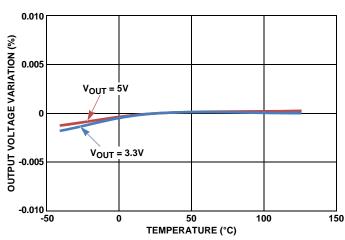


FIGURE 6. OUTPUT VOLTAGE vs TEMPERATURE (LOAD = 50mA)

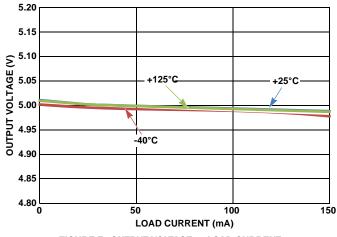


FIGURE 7. OUTPUT VOLTAGE vs LOAD CURRENT

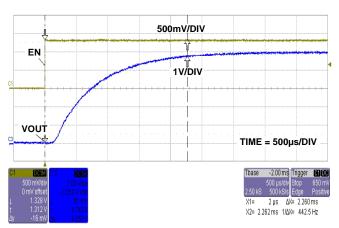


FIGURE 8. START-UP WAVEFORM

# **Typical Performance Curves** $v_{IN} = 14V$ , $l_{OUT} = 1mA$ , $v_{OUT} = 5V$ , $T_J = +25$ °C, unless otherwise specified. (Continued)

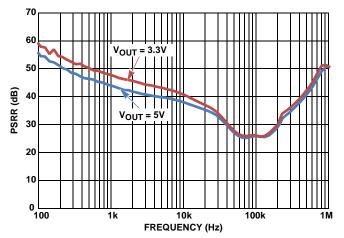


FIGURE 9. POWER SUPPLY REJECTION RATIO (LOAD = 150mA)

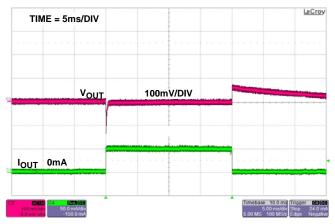


FIGURE 10. LOAD TRANSIENT RESPONSE

# **Functional Description**

#### **Functional Overview**

The ISL80138 is a high performance, high voltage, low-dropout regulator (LDO) with 150mA sourcing capability. The part is rated to operate over the -40 °C to +125 °C temperature range. Featuring ultra-low quiescent current, it is an ideal choice for "always-on" applications. It works well under a "load dump condition" where the input voltage could rise up to 40V. This LDO device also features current limit and thermal shutdown protection.

#### **Enable Control**

The ISL80138 has an enable pin, which turns the device on when pulled high. When EN is low, the IC goes into shutdown mode and draws less than  $2\mu A.$  In "always-on" applications, EN can be tied to IN.

#### **Current Limit Protection**

The ISL80138 has internal current limiting functionality to protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current largely independent of the output voltage. If the short or overload is removed from  $V_{OLIT}$ , the output returns to normal voltage regulation mode.

#### **Thermal Fault Protection**

In the event that the die temperature exceeds a typical value of +165°C, the output of the LDO will shut down until the die temperature cools down to a typical +145°C. The level of power dissipated, combined with the ambient temperature and the thermal impedance of the package, determines if the junction temperature exceeds the thermal shutdown temperature. See the "Power Dissipation" section on page 7 for more details.

# **Application Information**

### **Input and Output Capacitors**

A minimum  $0.1\mu F$  ceramic capacitor is recommended at the input for proper operation. For the output, a ceramic capacitor with a capacitance of  $10\mu F$  is recommended for the ISL80138 to maintain stability. The ground connection of the output capacitor should be routed directly to the GND pin of the device and also placed close to the IC.

### **Output Voltage Setting**

The ISL80138 output voltage is programmed using an external resistor divider as shown in Figure 11.

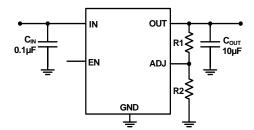


FIGURE 11. OUTPUT VOLTAGE SETTING

The output voltage is calculated using Equation 1:

$$V_{OUT} = 1.223V \times \left(\frac{R_1}{R_2} + 1\right)$$
 (EQ. 1)

### **Power Dissipation**

The junction temperature must not exceed the range specified in "Recommended Operating Conditions" on page 3. The power dissipation can be calculated using Equation 2:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$
 (EQ. 2)

The maximum allowable junction temperature,  $T_{J(MAX)}$  and the maximum expected ambient temperature,  $T_{A(MAX)}$  will determine the maximum allowable junction temperature rise ( $\Delta T_J$ ), as shown in Equation 3:

$$\Delta T_{J} = T_{J(MAX)} - T_{A(MAX)}$$
 (EQ. 3)

To calculate the maximum ambient operating temperature, use the junction-to-ambient thermal resistance  $(\theta_{JA})$  as shown in Equation 4:

$$T_{J(MAX)} = P_{D(MAX)} \times \theta_{JA} + T_{A}$$
 (EQ. 4)

### **Board Layout Recommendations**

A good PCB layout is important to achieve expected performance. Consideration should be taken when placing the components and routing the trace to minimize the ground impedance and keep the parasitic inductance low. The input and output capacitors should have a good ground connection and be placed as close to the IC as possible. The feedback trace in the adjustable version should be away from other noisy traces. The 14 Ld HTSSOP package uses the copper area on the PCB as a heat-sink. The EPAD of this package must be soldered to the copper plane (GND plane) for effective heat dissipation. Figure 12 shows a curve for  $\theta_{JA}$  of the package for different copper area sizes.

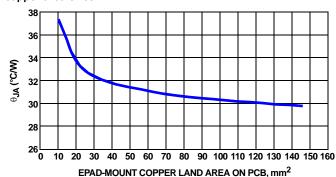


FIGURE 12.  $\theta_{\mbox{\scriptsize JA}}$  vs epad-mount copper land area on PCB

### ISL80138

# **Revision History**

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Rev.

| DATE             | REVISION | CHANGE           |
|------------------|----------|------------------|
| January 11, 2012 | FN7969.0 | Initial Release. |

# **Products**

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For a complete listing of Applications, Related Documentation and Related Parts, please see the respective device information page on intersil.com: ISL80138

To report errors or suggestions for this datasheet, please go to www.intersil.com/askourstaff

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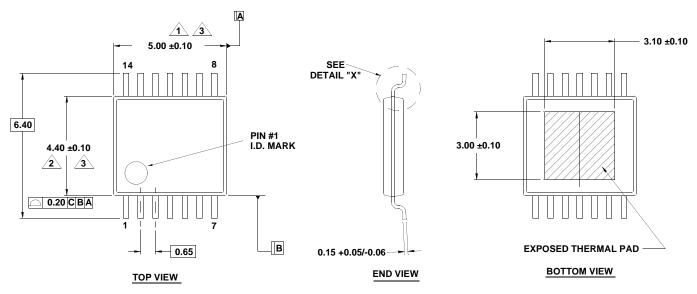
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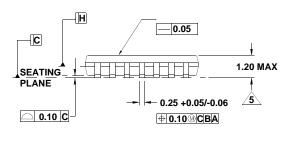
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# **Package Outline Drawing**

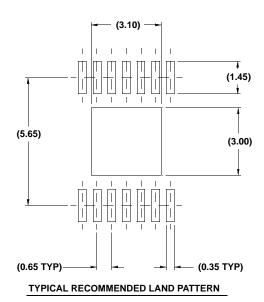
#### M14.173B

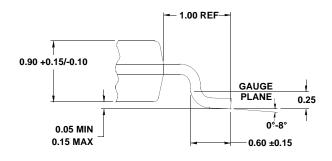
14 LEAD HEAT-SINK THIN SHRINK SMALL OUTLINE PACKAGE (HTSSOP) Rev 1, 1/10





SIDE VIEW





DETAIL "X"

#### NOTES:

- Dimension does not include mold flash, protrusions or gate burrs.
  Mold flash, protrusions or gate burrs shall not exceed 0.15 per side.
- 2. Dimension does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 per side.
- 3. Dimensions are measured at datum plane H.
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.
- Dimension does not include dambar protrusion.
  Allowable protrusion shall be 0.80mm total in excess of dimension at maximum material condition.
  - Minimum space between protrusion and adjacent lead is 0.07mm.
- 6. Dimension in () are for reference only.
- 7. Conforms to JEDEC MO-153, variation ABT-1.